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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO
09/382,442	08/25/1999	ALAN R. REINBERG	303.522US1	5236
21186	7590 05/30/2003			
SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.			EXAMINER	
P.O. BOX 2938 MINNEAPOLIS, MN 55402			BOOTH, RICHARD A	
			ART UNIT	PAPER NUMBER

2812 DATE MAILED: 05/30/2003

Please find below and/or attached an Office communication concerning this application or proceeding.

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		Application No.	Applicant(s)	<del>-y-</del>
		09/382,442	REINBERG, ALAN R.1	
Office Action Summary		Examiner	Art Unit	
		Richard A. Booth	2812	
Périod fo	The MAILING DATE of this communication Reply	on appears on the cover sheet wi	th the correspondence address	
THE I - External from the control of	ORTENED STATUTORY PERIOD FOR IN MAILING DATE OF THIS COMMUNICAT nsions of time may be available under the provisions of 37 sold (6) MONTHS from the mailing date of this communicat period for reply specified above is less than thirty (30) day period for reply is specified above, the maximum statutory re to reply within the set or extended period for reply will, by reply received by the Office later than three months after the patent term adjustment. See 37 CFR 1.704(b).	ION.  CFR 1.136(a). In no event, however, may a nation.  s, a reply within the statutory minimum of thirt period will apply and will expire SIX (6) MON by statute, cause the application to become AB	eply be timely filed y (30) days will be considered timely. THS from the mailing date of this communication. ANDONED (35 U.S.C. § 133).	
1)⊠	Responsive to communication(s) filed o	n <u>17 <i>March 2003</i></u> .		
2a)⊠	This action is <b>FINAL</b> . 2b)	This action is non-final.		
3)□ Dispositi	Since this application is in condition for closed in accordance with the practice usion of Claims	allowance except for formal mat under <i>Ex part</i> e Quayle, 1935 C.I	ters, prosecution as to the merits is D. 11, 453 O.G. 213.	
4)⊠	Claim(s) <u>1-14,26-32 and 35-39</u> is/are pe	ending in the application.		
	4a) Of the above claim(s) 3,26-32 and 35	5-39 is/are withdrawn from consi	deration.	
5)□	Claim(s) is/are allowed.			
6)⊠	Claim(s) 1,2 and 4-14 is/are rejected.			
7)	Claim(s) is/are objected to.			
8)[	Claim(s) are subject to restriction	and/or election requirement.	·	
Applicat	ion Papers			
,—	The specification is objected to by the Ex			
10)	The drawing(s) filed on is/are: a)			
	Applicant may not request that any objection			
11)[	The proposed drawing correction filed on		isapproved by the Examiner.	
	If approved, corrected drawings are require	•		
12)	The oath or declaration is objected to by	the Examiner.		
-	under 35 U.S.C. §§ 119 and 120			
13)[	Acknowledgment is made of a claim for	foreign priority under 35 U.S.C.	§ 119(a)-(d) or (f).	
a)	☐ All b)☐ Some * c)☐ None of:		•	
	1. Certified copies of the priority doc			
	2. Certified copies of the priority doc			
* (	<ol> <li>Copies of the certified copies of the application from the Internation</li> <li>See the attached detailed Office action for</li> </ol>	nal Bureau (PCT Rule 17.2(a)).		
14) 🔲 🗸	Acknowledgment is made of a claim for do	omestic priority under 35 U.S.C.	§ 119(e) (to a provisional application	ı).
	a) $\square$ The translation of the foreign langua Acknowledgment is made of a claim for d			
Attachmer	nt(s)	_		
2) Noti	ce of References Cited (PTO-892) ce of Draftsperson's Patent Drawing Review (PTO-9 mation Disclosure Statement(s) (PTO-1449) Paper	948) 5) Notice of	Summary (PTO-413) Paper No(s) Informal Patent Application (PTO-152)	
I C Botont and	Trademark Office	· · · · · · · · · · · · · · · · · · ·		

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### **DETAILED ACTION**

#### Election/Restrictions

Applicant's election without traverse of the embodiment described at page 9, lines 13-18 in Paper No. 27 is acknowledged.

# Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1-2, 4-5, and 7-10 are rejected under 35 U.S.C. 103(a) as being unpatentable over Nakanishi, U.S. Patent 5,145,797 in view of Lisenker et al., WO 94/19829 and further in view of Admitted prior art.

Nakanishi shows the invention substantially as claimed including providing a semiconductor layer 1 having a surface; heating the layer in an atmosphere during thermal oxidfabricating a memory circuit having a programming operation and an erasing operation, comprising single bit data using the semiconductor layer 1, the fabricating comprising fabricating a gate region 3 in the layer; treating a portion of the surface to form a thin layer 7 of insulator film adjacent to the gate region and under the gate region and forming a second gate region 5 over the first gate region (see figs. 1A-1D and col. 2-lines 28-66).

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Nakanishi fails to expressly disclose providing a semiconductor layer having a surface, heating the layer in an atmosphere comprising a hydrogen isotope wherein the hydrogen isotope is incorporated into the layer; and heating the gate region and the thin layer in an atmosphere comprising a hydrogen isotope.

Admitted prior art discloses performing a post-metal passivation process using hydrogen (see page 4, lines 27-30 of specification). Additionally, Lisenker et al. discloses replacing hydrogen with deuterium in a polysilicon deposition process or in a passivation process or in any process in which hydrogen is employed (see paragraph bridging pages 8-9). In view of this disclosure, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the process of Nakanishi so that the deposition of the polysilicon layers 3 and 5 and the passivation process is employed using deuterium as suggested by the combination of Lisenker et al. and the Admitted prior art because bonds formed with deuterium are stronger than those formed with hydrogen (see page 9, lines 5-14)

With respect to claims 4-5, note that the thermal oxidation process recited above will be at such a temperature as to oxidize and anneal the semiconductor layer.

Claim 6 is rejected under 35 U.S.C. 103(a) as being unpatentable over Nakanishi, U.S. Patent 5,145,797 in view of Lisenker et al., WO 94/19829 and further in view of Admitted prior art as applied to claims 1-2, 4-5, and 7-10 above, and further in view of Nakajima et al., U.S. Patent 5,397,724.

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Nakanishi, Lisenker et al., and the Admitted prior art are applied as above but fail to expressly disclose subjecting the semiconductor to ammonia enriched in hydrogen isotope at an elevated temperature.

Nakajima et al. teaches the formation of a memory device in which a passivation layer 32 of silicon nitride is formed thereover by CVD (see fig. 8F and col. 7-lines 42-57). Note that it is well known in the art that silicon nitride is commonly formed through CVD using an ammonia precursor. In view of this disclosure, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the process of Nakanishi modified by Lisenker et al. and the Admitted prior art so as to subject the semiconductor to ammonia enriched in hydrogen isotope because Nakajima et al. suggests using silicon nitride as an overlying passivation layer for a memory device and Lisenker et al. teaches the desirability of replacing hydrogen with deuterium in all semiconductor processing steps.

Claims 11-14 are rejected under 35 U.S.C. 103(a) as being unpatentable over Nakanishi, U.S. Patent 5,145,797 in view of Lisenker et al., WO 94/19829 and further in view of Admitted prior art as applied to claims 1-2, 4-5, and 7-10 above, and further in view of Sheu, U.S. Patent 4,840,917.

Nakanishi, Lisenker et al., and the Admitted prior art are applied as above but fail to expressly disclose forming a field oxide in the substrate followed by annealing in a hydrogen isotope material at a temperature greater than 800 Celsius.

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Sheu discloses forming field oxides followed by performing hydrogen annealing at 1000 Celsius in order to incorporate hydrogen into the active area (see col. 1-lines 27-35). In view of this disclosure, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the process of Nakanishi modified by Lisenker et al. and the Admitted prior art so as to form a field oxide followed by annealing with hydrogen because this reduces the surface state density of the device. Furthermore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to replace the hydrogen with deuterium as suggested by Lisenker et al. because of the stronger bonds that silicon forms with deuterium.

# Response to Arguments

Applicant's arguments with respect to claims 1-2 and 4-14 have been considered but are most in view of the new ground(s) of rejection.

#### Conclusion

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Richard A. Booth whose telephone number is 308-3446. The examiner can normally be reached on Monday-Thursday from 7:30-6:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, John Niebling can be reached on 308-3325. The fax phone numbers for the organization where this application or proceeding is assigned are 308-7724 for regular communications and 308-7724 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is 308-1782.

Richard A. Booth Primary Examiner Art Unit 2812

May 21, 2003 Art Unit 28